# silicon systems\*

# SSI 32P541A Read Data Processor

# **Preliminary Data**

July, 1990

#### DESCRIPTION

The SSI 32P541A is a bipolar integrated circuit that provides all data processing necessary for detection and qualification of MFM or RLL encoded read signals.

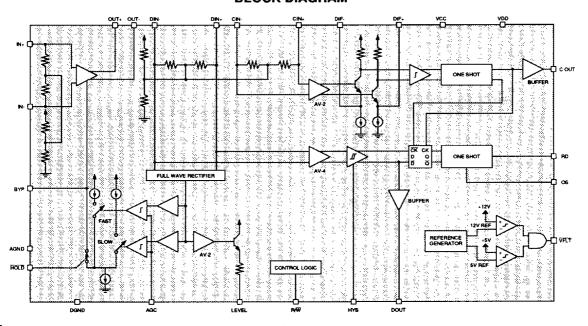
In read mode the SSI 32P541A provides amplification and qualification of head preamplifier outputs. Pulse qualification is accomplished using level qualification of differentiated input zero crossings. An AGC amplifier is used to compensate for variations in head preamp output levels, presenting a constant input level to the pulse qualification circuitry. The AGC loop can be disabled so that a constant gain can be used for embedded servo decoding or other processing needs.

In write mode the circuitry is disabled and the AGC gain stage input impedance is switched to a lower level to allow fast setting of the input coupling capacitors during a write to read transition. The SSI 32P541A requires +5V and +12V power supplies and is available in a 28-pin PLCC, 24-pin DIP and 24-pin SOL.

#### **FEATURES**

- Level qualification supports high resolution MFM and RLL encoded data retrieval
- Wide bandwidth AGC input amplifier
- Standard 12V ± 10% and 5V ± 10% supplies
- Supports embedded servo pattern decoding
- Write to read transient suppression
- Fast and slow AGC attack regions for fast transient recovery
- Internal voltage fault indicator
- ≤±1.5 ns pulse pairing

#### **BLOCK DIAGRAM**



#### CIRCUIT OPERATION

#### **READ MODE**

In the read mode (R/W input high or open) the input read signal is amplified and qualified using an AGC amplifier and pulse level qualification of the detected signal peaks.

The amplified head signals are AC coupled to the IN + and IN - pins of the AGC amplifier that is gain controlled by full wave rectifying and amplifying the (DIN+ - DIN-) voltage level and comparing it to a reference level at the AGC pin. A fast attack mode, which supplies a 1.7 mA charging current for the capacitor at the BYP pin, is entered whenever the instantaneous DIN± level is more than 125% of set level. Between 100% and 125% the slow attack mode is invoked, providing 0.18 mA of charging current. The two attack modes allow rapid AGC recovery from a write to read transition while reducing zero crossing distortion once the amplifier is in range.

The level at the AGC pin should be set such that the differential voltage level at the DIN+, DIN- pins is 1.00 Vpp at the OUT+, OUT- pins which allows for up to 6 dB loss in any external filter connected between the OUT+, OUT- outputs and the DIN+, DIN- inputs.

Gain of the AGC section is nominally

$$\frac{Av2}{Av1} = \exp -\left(\frac{V2 - V1}{5.8 + V1}\right)$$

Where: Av1 and Av2 are initial and final amplifier gains. V1, V2 are initial and final voltages on the BYP pin.

 $Vt = (K \times T)/q = 26 \text{ mV}$  at room temperature.

One filter for both data (DIN+, DIN- input) and clock (CIN+, CIN- input) paths, or a separate filter for each path may be used. If two filters are used, care must be exercised to control time delays so that each path is timed properly. A multi-pole Bessell filter is typically used for its linear phase or constant group delay characteristics.

The filtered data path signal is fed into a hysteresis comparator that is set at a fraction of the input signal level by using an external filter/network between the LEVEL and HYS pins. Using this approach allows

setting the AGC slow attack and decay times slow enough to minimize distortion of the clock path signal. This "feed-forward" technique, utilizing a fraction of the rectified data path input available at the LEVEL pin as the hysteresis threshold, is especially useful in the slow decay mode of the AGC loop. By using a short time constant for the hysteresis level, the qualification method can continue as the AGC amplifier gain is slowly ramped up. This level will also shorten the write to read transient recovery time without affecting data timing as the circuit will be properly decoding before the AGC gain has settled to its final value. The comparator output is the "D" input of a D type flip-flop. The DOUT pin provides a buffered test point for monitoring this function.

The filtered clock path signal is differentiated to transform signal peaks to zero-crossings which clock an edge-trigger circuit to provide output pulses at each zero-crossing. The pulses are used to clock the D type flip-flop. The COUT pin is a buffered test point for monitoring this function.

The differentiator function is set by an external network between the DIF+, DIF- pins. The transfer function is:

$$AV = \frac{-2000Cs}{LCs^2 + (R+92)Cs + 1}$$

Where: C = external capacitor (20 pF to 150 pF)

L = external inductor

R = external resistor

$$s = i\omega = j2\pi f$$

During normal operation the differentiator circuit clocks the D flip-flop on every positive and negative peak of the signal input to CIN+, CIN-. The D input to the flip-flop only changes state when the signal applied to the DIN+, DIN- inputs exceeds the hysteresis comparator threshold opposite in polarity to the previous peak that exceeded the threshold.

The clocking path, then, determines signal timing and the data path determines validity by blocking signal peaks that do not exceed the hysteresis comparator threshold.

The delays from CIN+, CIN- inputs to the flip-flop clock input and from the DIN+, DIN- inputs to the flip-flop D input are well matched.

2-12 0790 - rev.

#### WRITE (DISABLED) MODE

In the write or disabled mode (RIW input low) the digital circuitry is disabled and the AGC amplifier input impedance is reduced. In addition the AGC amplifier, gain is set to maximum so that the loop is in its fast attack mode when changing back to Read Mode. The lowered input impedance facilitates more rapid settling of the write to read transient by reducing the time constant of the network between the SSI 32P541A and read/write preamplifier, such as the SSI 32R510.

Internal SSI 32P541A timing is such that this settling is accomplished before the AGC loop is activated when going to read mode. Coupling capacitors should be chosen with as low a value as possible, consistent with bandwidth requirements, to allow more rapid settling.

#### LAYOUT CONSIDERATIONS

The SSI 32P541A is a high gain wide bandwidth device that requires care in layout. The designer should keep analog signal lines as short as possible and well balanced. Use of a ground plane is recommended along with supply bypassing and separation of the SSI 32P541A and associated circuitry grounds from other circuits on the disk drive PCB.

#### LOW VOLTAGE FAULT DETECTION

A low voltage detection circuit monitors both supplies and pulls an open collector TTL output low when either supply drops below their trip point. This option is available only in the 28-pin PLCC package.

| R/W | HOLD | MODE   |
|-----|------|--|
| 1   | 1    | READ - Read amp on, AGC active, Digital section active   |
| 1   | 0    | HOLD - Read amp on, AGC gain held constant Digital section active                                    |
| 0   | ×    | WRITE - AGC gain switched to maximum, Digital section inactive, common mode input resistance reduced |

#### PIN DESCRIPTION

| NAME       | TYPE | DESCRIPTION  |
|------------|------|--|
| VCC        |      | 5 volt power supply  |
| VDD        |      | 12 volt power supply   |
| AGND, DGND |      | Analog and Digital ground pins   |
| R/₩        |      | TTL compatible read/write control pin                                  |
| IN+, IN-   | ı    | Analog signal input pins   |
| OUT+, OUT- | 0    | AGC Amplifier output pins  |
| BYP        |      | The AGC timing capacitor is tied between this pin and AGND             |
| HOLD       | 1    | TTL compatible pin that holds the AGC gain when pulled low             |
| AGC        | 1    | Reference input voltage level for the AGC circuit                      |
| DIN+, DIN- | ī    | Analog input to the hysteresis comparator                              |
| HYS        | 1    | Hysteresis level setting input to the hysteresis comparator            |
| LEVEL      | 0    | Provides rectified signal level for input to the hysteresis comparator |
| DOUT       | 0    | Buffered test point for monitoring the flip-flop D input               |

#### PIN DESCRIPTION (Continued)

| NAME       | TYPE | DESCRIPTION  |
|------------|------|--|
| CIN+, CIN- | 1    | Analog input to the differentiator   |
| DIF+, DIF- |      | Pins for external differentiating network                                      |
| COUT       | 0    | Buffered test point for monitoring the clock input to the flip-flop            |
| os         |      | Connection for read output pulse width setting capacitor                       |
| RD         | 0    | TTL compatible read output   |
| VFLT*      | 0    | Open collector output that goes low when a low power supply fault is detected. |

<sup>\*</sup>VFLT output offered in 28-pin PLCC package only.

### **ELECTRICAL CHARACTERISTICS**

Unless otherwise specified 4.5  $\leq$  VCC  $\leq$  5.5V, 10.8V  $\leq$  VDD  $\leq$  13.2V, 25°C  $\leq$  Tj  $\leq$  135°C.

#### **ABSOLUTE MAXIMUM RATINGS**

Operation above absolute maximum ratings may permanently damage the device.

| PARAMETER                 | RATING                     | UNIT |
|---------------------------|----------------------------|------|
| 5V Supply Voltage, VCC    | 6                          | V    |
| 12V Supply Voltage, VDD   | 14                         | ٧    |
| Storage Temperature       | -65 to 150                 | °C   |
| Lead Temperature          | 260                        | °C   |
| R/W, IN+, IN-, HOLD, VFLT | -0.3 to VCC + 0.3          | ٧    |
| RD                        | -0.3V to VCC + 0.3V or +12 | mA   |
| All others                | -0.3 to VDD + 0.3          | ν    |

#### **POWER SUPPLY**

| PARAMETER                | CONDITIONS                   | MIN | NOM | MAX | UNIT |
|--------------------------|------------------------------|-----|-----|-----|------|
| ICC - VCC Supply Current | Outputs unloaded             |     |     | 14  | mA   |
| IDD - VDD Supply Current | Outputs unloaded             |     |     | 70  | mA   |
| Pd - Power Dissipation   | Outputs unloaded, Tj = 135°C |     |     | 730 | mW   |

2-14 0790 - rev.

#### **LOGIC SIGNALS**

| PARAMETER                 | CONDITIONS    | MIN  | NOM | MAX  | UNIT     |
|---------------------------|---------------|------|-----|------|----------|
| VIL - Input Low Voltage   |               | -0.3 |     | 0.8  | ٧        |
| VIH - Input High Voltage  |               | 2.0  |     |      | ٧        |
| IIL - Input Low Current   | VIL = 0.4V    | 0.0  |     | -0.4 | mA       |
| IIH - Input High Current  | VIH = 2.4V    |      |     | 100  | μΑ       |
| VOL - Output Low Voltage  | IOL = 4.0 mA  |      |     | 0.4  | V        |
| VOH - Output High Voltage | IOH ≈ -400 μA | 2.4  |     |      | <b>V</b> |

#### **MODE CONTROL**

| PARAMETER                     | CONDITIONS   | MIN | NOM | MAX | UNIT |
|-------------------------------|--|-----|-----|-----|------|
| Read to Write Transition Time |  |     |     | 1.0 | μs   |
| Write to Read Transition Time | AGC settling not included, transition to high input resistance | 1.2 |     | 3.0 | μs   |
| Read to Hold Transition Time  |  |     |     | 1.0 | μs   |

#### WRITE MODE

| PARAMETER                                | CONDITIONS    | MIN | МОМ | MAX | UNIT |
|--|---------------|-----|-----|-----|------|
| Common Mode Input Impedance (both sides) | R/W pin = low |     | 250 |     | Ω    |

#### **READ MODE**

Unless otherwise specified IN+ and IN- are AC coupled, OUT+, and OUT- are loaded differentially with >  $600\Omega$  and each side is loaded with < 10 pF to GND, a 2000 pF capacitor is connected between BYP and GND, OUT+ is AC coupled to DIN+, OUT- is AC coupled to DIN-, AGC pin voltage is 2.2 VDC.

#### **AGC AMPLIFIER**

| PARAMETER                      | CONDITIONS                            | MIN | МОМ  | MAX | UNIT   |
|--------------------------------|---------------------------------------|-----|------|-----|--------|
| Differential Input Resistance  | V(IN+ - IN-) = 100 mVpp<br>@ 2.5 MHz  |     | 5K   |     | Ω      |
| Differential Input Capacitance | V(IN+ - IN-) = 100 mVpp<br>@ 2.5 MHz  |     |      | 10  | pF     |
| Common Mode Input Impedance    | R/W pin high                          |     | 1.8  |     | ΚΩ     |
| (both sides)                   | R/₩ pin low                           |     | 0.25 |     | ΚΩ     |
| Minimum Gain Range             | 1.0 Vpp ≤ V(OUT+ – OUT-)<br>≤ 2.5 Vpp | 4.0 |      | 83  | V/V    |
| Input Noise Voltage            | Gain set to maximum                   |     |      | 30  | nV/√Hz |

#### AGC AMPLIFIER (Continued)

| PARAMETER   | CONDITIONS   | MIN  | МОМ  | MAX  | UNIT  |
|---|--|------|------|------|-------|
| Bandwidth   | Gain set to maximum -3 dB point  | 30   |      |      | MHz   |
| Maximum Output Voltage Swing                            | Set by AGC pin voltage   | 3.0  |      |      | Vpp   |
| OUT+ to OUT- Pin Current                                | No DC path to GND  | ±3.2 |      |      | mA    |
| Output Resistance                                       |  | 12   |      | 32   | Ω     |
| Output Capacitance                                      |  |      |      | 15   | рF    |
| Maximum AGC Amplifier<br>Output Offset                  | Vout offset (max. gain) -Vout offset (min. gain) VBYP = 2.5 to 4.5V                              |      |      | 300  | mV    |
| (DIN+ - DIN-) Input Voltage<br>Swing VS AGC Input Level | 30 mVpp V(IN+ – IN-)<br>≤ 550 mVpp 0.5 Vpp<br>≤ V(DIN+ – DIN-) ≤ 1.5 Vpp                         | 0.37 |      | 0.56 | Vpp/V |
| (DIN+ – DIN-) Input Voltage<br>Swing Variation          | 30 mVpp V(IN+ - IN-)<br>≤ 550 mVpp AGC Fixed,<br>over supply & temperature                       |      |      | 8    | %     |
| Gain Decay Time (Td)                                    | Vin = 300 mVpp-> 150 mVpp<br>at 2.5 MHz, Vout to 90% of<br>final value Figure 1a                 |      | 50   |      | μs    |
| Gain Attack time (Ta)                                   | From Write to Read transition to Vout at 110% of final value Vin = 400 mVpp @ 2.5 MHz. Figure 1b |      | 4    |      | μѕ    |
| Fast AGC Capacitor Charge<br>Current                    | V(DIN+ - DIN-) = 1.6V<br>V(AGC) = 2.2V   | 1.3  |      | 2.0  | mA    |
| Slow AGC Capacitor Charge<br>Current                    | V(DIN+ - DIN-) = 1.6V Vary<br>V(AGC) until slow discharge  | 0.14 |      | 0.22 | mA    |
| Fast to Slow Attack Switchover Point                    | $\frac{V(DIN+-DIN-)}{V(DIN+-DIN-)}$ Final  |      | 1.25 |      | ļ     |
| AGC Capacitor Discharge Current                         | V(DIN+ - DIN-) = 0.0V  |      |      |      |       |
|   | Read Mode  |      | 4.5  |      | μΑ    |
|   | Hold Mode  | -0.2 |      | +0.2 | μА    |
| CMRR (Input Referred)                                   | V(IN+) = V(IN-) = 100  mVpp<br>@ 5 MHz,gain at max.  | 40   |      |      | dB    |
| PSRR (Input Referred)                                   | ΔVCC or ΔVDD = 100 mVpp<br>@ 5 MHz, gain at max.   | 30   |      |      | dB    |

2-16 0790 - rev.

#### **HYSTERESIS COMPARATOR**

| PARAMETER   | CONDITIONS   | MIN      | NOM | MAX      | UNIT  |
|---|--|----------|-----|----------|-------|
| Input Signal Range  |  |          |     | 1.5      | Vpp   |
| Differential Input Resistance                               | V(DIN+ - DIN-) = 100 mVpp<br>@ 2.5 MHz   | 5        |     | 11       | ΚΩ    |
| Differential Input Capacitance                              | V(DIN+ - DIN-) = 100 mVpp<br>@ 2.5 MHz   |          |     | 6.0      | pF    |
| Common Mode Input Impedance                                 | (both sides)   |          | 2.0 |          | ΚΩ    |
| Comparator Offset Voltage                                   | HYS pin at GND, ≤ 1.5 KΩ<br>across DIN+, DIN-  |          |     | 10       | mV    |
| Peak Hysteresis Voltage vs HYS pin voltage (input referred) | At DIN+, DIN- pins<br>1V < V (HYS) < 3V  | 0.16     |     | 0.25     | V/V   |
| HYS Pin Input Current                                       | 1V < V (HYS) < 3V  | 0.0      |     | -20      | μА    |
| Level Pin Output<br>Voltage vs V(DIN+ - DIN-)               | 0.6 <   V (DIN+ - DIN-)  <br><1.3 Vpp, 10 KΩ from LEVEL<br>pin to GND                | 1.5      |     | 2.5      | V/Vpp |
| Hysteresis threshold margin as a % of V(DIN+ – DIN-) peak   | V(HYS) = At a typical of 60% *V(AGC) or V(LEVEL) 1V < V(HYS) < 3V *see figures 5 & 6 | -15      |     | +15      | %Peak |
| LEVEL Pin Max Output Current                                |  | 3.0      |     |          | mA    |
| LEVEL Pin Output Resistance                                 | I(LEVEL) = 0.5 mA  |          | 180 |          | Ω     |
| DOUT Pin Output Low Voltage                                 | 0.0 ≤ IOL ≤ 0.5 mA   | VDD -4.0 |     | VDD -2.8 | ٧     |
| DOUT Pin Output High Voltage                                | 0.0 ≤ IOH ≤ 0.5 mA   | VDD -2.5 |     | VDD -1.8 | V     |

<sup>\*</sup> In an open loop configuration where reference is V(AGC) tolerance can be slightly higher.

#### **ACTIVE DIFFERENTIATOR**

| PARAMETER                      | CONDITIONS  | MIN  | МОМ | MAX  | UNIT |
|--------------------------------|---|------|-----|------|------|
| Input Signal Range             |   |      |     | 1.5  | Vpp  |
| Differential Input Resistance  | V(CIN+ - CIN-) = 100 mVpp<br>@ 2.5 MHz  | 5.8  |     | 11.0 | ΚΩ   |
| Differential Input Capacitance | V(CIN+ - CIN-) = 100 mVpp<br>@ 2.5 MHz  |      |     | 6.0  | pF   |
| Common mode Input Impedance    | (both sides)  |      | 2.0 |      | ΚΩ   |
| Voltage Gain From CIN± to DIF± | $R(DIF+ to DIF-) = 2 K\Omega$   | 1.7  |     | 2.2  | V/V  |
| DIF+ to DIF- Pin Current       | Differentiator Impedance<br>must be set so as not to clip<br>signal at this current level | ±1.3 |     |      | mA   |

#### **ACTIVE DIFFERENTIATOR** (Continued)

| PARAMETER   | CONDITIONS                | MIN               | NOM      | MAX  | UNIT |
|---|---------------------------|-------------------|----------|------|------|
| Comparator Offset Voltage                         | DIF+, DIF- are AC Coupled |                   |          | 10.0 | mV   |
| COUT Pin Output Low Voltage                       | 0.0 ≤ IOH ≤ 0.5 mA        |                   | VDD -3.0 |      | ٧    |
| COUT Pin Output Pulse voltage<br>V(high) - V(low) | 0.0 ≤ IOH ≤ 0.5 mA        | IOH ≤ 0.5 mA +0.4 |          |      | V    |
| COUT Pin Output Pulse Width                       | 0.0 ≤ IOH ≤ 0.5 mA        |                   | 30       |      | ns   |

#### **OUTPUT DATA CHARACTERISTICS** (See Figure 2)

Unless otherwise specified V(CIN+-CIN-) = V(DIN+-DIN-) = 1.0 Vpp AC coupled sine wave at 2.5 MHz differentiating network between DIF+ and DIF- is  $100\Omega$  in series with 65 pF, V(Hys) = 1.8 DC, a 60 pF capacitor is connected between OS and VCC, RD- is loaded with a 4 K $\Omega$  resistor to VCC and a 10 pF capacitor to GND.

| PARAMETER                            | CONDITIONS  | MIN | NOM | MAX  | UNIT |
|--------------------------------------|---|-----|-----|------|------|
| D-Flip-Flop Set Up Time (Td1)        | Min delay from V(DIN+ DIN-) exceeding threshold to V(DIF+ - DIF-) reaching a peak | 0   |     |      | ns   |
| Propagation Delay (Td3)              |   |     |     | 110  | ns   |
| Output Data Pulse Width<br>Variation | Td5 = 670 Cos,<br>50 pF ≤ Cos ≤ 200 pF  |     |     | ±15  | %    |
| Pulse Pairing                        | (Td3 - Td4)   |     |     | ±1.5 | ns   |
| Output Rise Time                     | VOH = 2.4V  |     |     | 14   | ns   |
| Output Fall Time                     | VOL = 0.4V  |     |     | 18   | ns   |

#### SUPPLY VOLTAGE FAULT DETECTION

| PARAMETER               | CONDITIONS                        | MIN | МОМ | MAX  | UNIT     |
|-------------------------|-----------------------------------|-----|-----|------|----------|
| VDD Fault Threshold     |                                   | 9.1 |     | 10.3 | V        |
| VCC Fault Threshold     |                                   | 4.1 |     | 4.4  | ٧        |
| VOL Output Low Voltage  | 4.5 < VCC < 5.5V,<br>IOL = 1.6 mA |     |     | 0.4  | ٧        |
|                         | 1.0 < VCC < 4.5V,<br>IOL = 0.5 mA |     |     | 0.4  | <b>V</b> |
| IOH Output High Current |                                   |     |     | 25   | μΑ       |

2-18 0790 - rev.

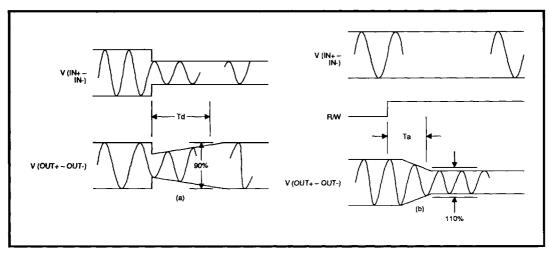


FIGURE 1(a), (b): AGC Timing Diagrams

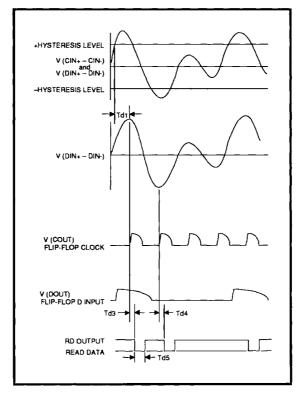
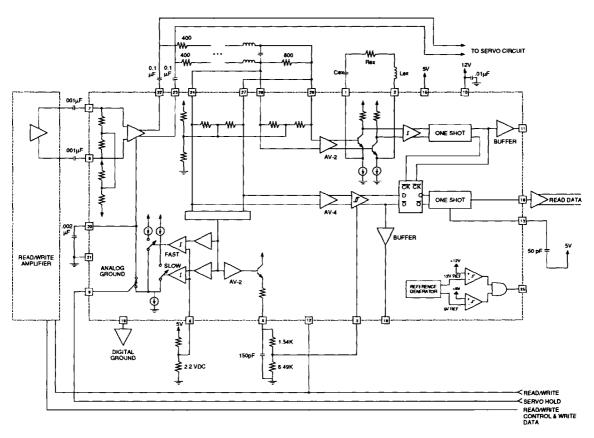


FIGURE 2: Timing Diagram



NOTE: Circuit traces for the 12V bypass capacitor and the AGC Hold capacitor should be as short as possible with both capacitors returned to the Analog Ground Pin. Component values, where given, are for a 5Mbit/s system.

Above pin numbers are for the 28-pin PLCC package.

FIGURE 3: Typical Read/Write Electronics Set Up

2-20 0790 - rev.

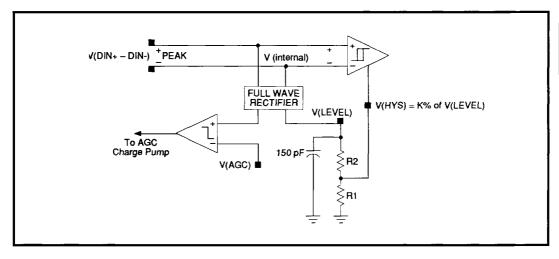


FIGURE 4: Feed Forward Mode

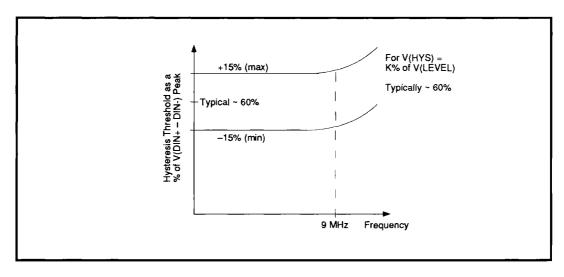
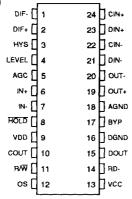


FIGURE 5: Percentage Threshold vs. Frequency

2-21

#### **PACKAGE PIN DESIGNATIONS**

(TOP VIEW)



24-Lead PDIP, SOL

LEVEL VFLT AGC DIN-IN+ 23 OUT-OUT+ HOLD 21 AGND BYP von F 19 DGND соит П 90 ė 28-Lead PLCC

THERMAL CHARACTERISTICS: Ø ja

| 24-Lead PDIP | 115°C/W |  |  |
|--------------|---------|--|--|
| 24-Lead SOL  | 80°C/W  |  |  |
| 28-Lead PLCC | 65°C/W  |  |  |

CAUTION: Use handling procedures necessary for a static sensitive component.

#### **ORDERING INFORMATION**

| PART DESCRIPTION                | ORDERING NO.   | PKG. MARK      |
|---------------------------------|----------------|----------------|
| SSI 32P541A Read Data Processor | -              |                |
| 24-Lead PDIP                    | SSI 32P541A-P  | SSI 32P541A-P  |
| 28-Lead PLCC                    | SSI 32P541A-CH | SSI 32P541A-CH |
| 24-Lead SOL                     | SSI 32P541A-CL | SSI 32P541A-CL |

Preliminary Data:

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